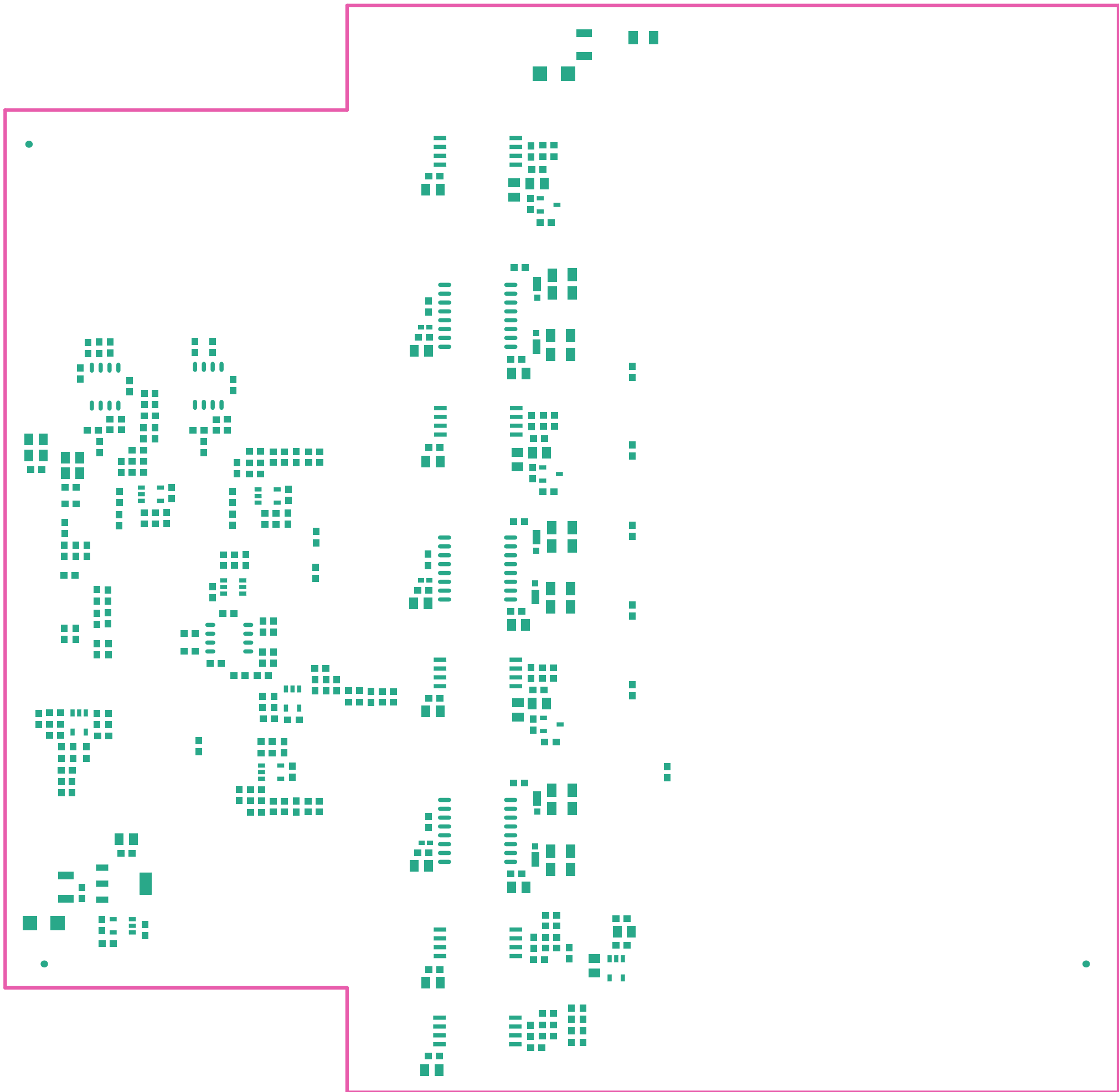
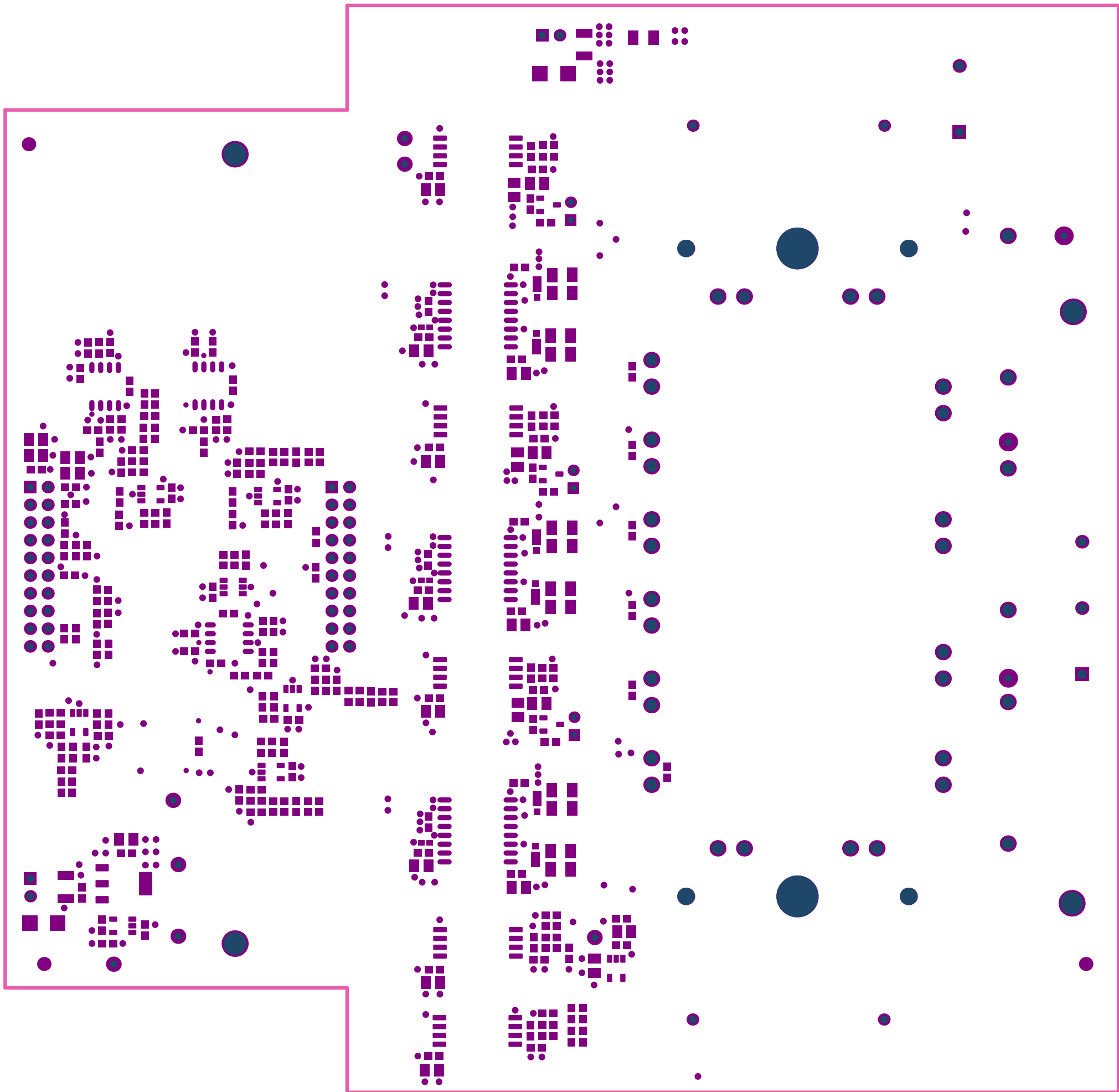


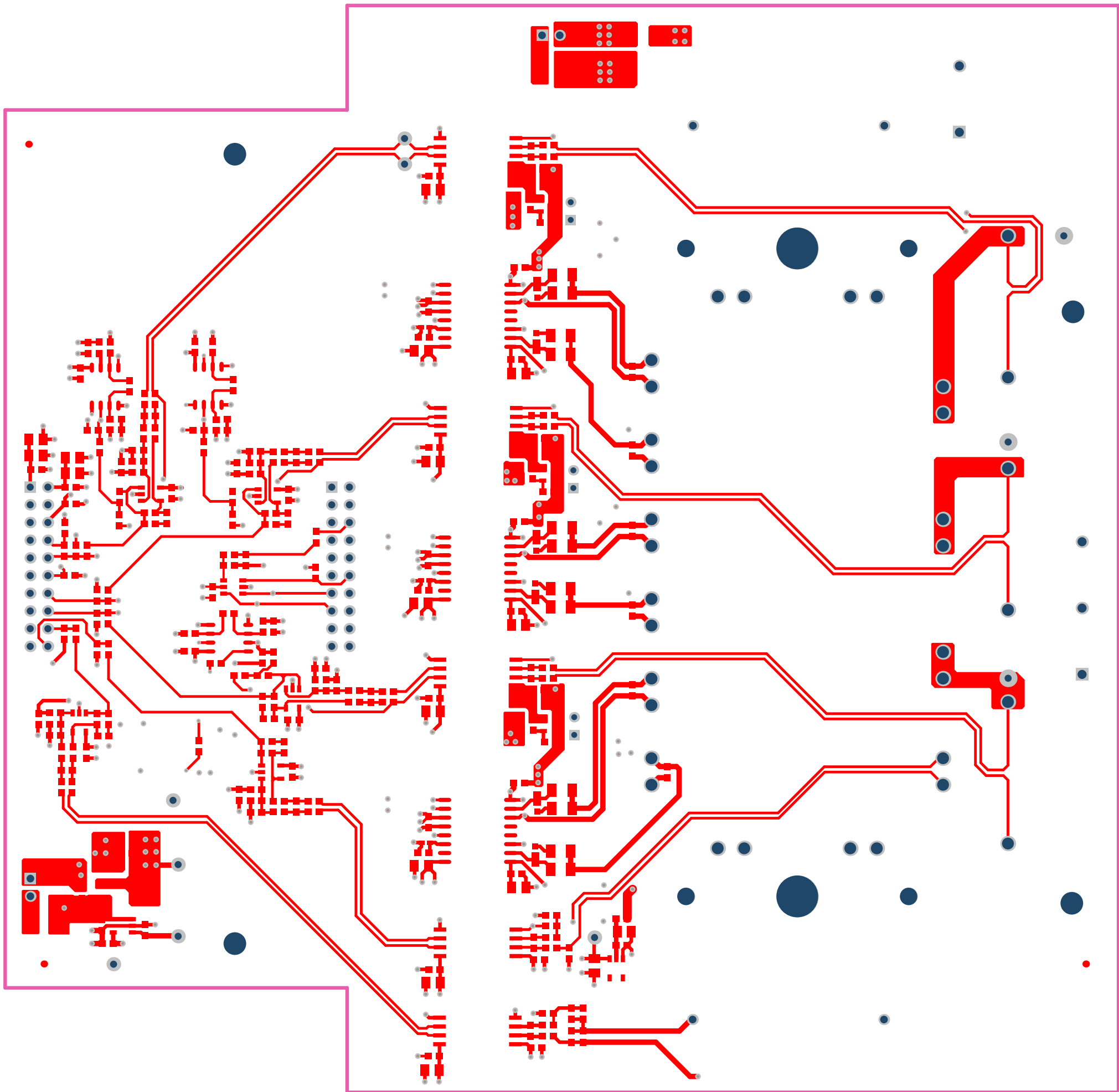
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01540	
Top Overlay	GENERATED : 24-Nov-17 4:25:55 PM	TEXAS INSTRUMENTS



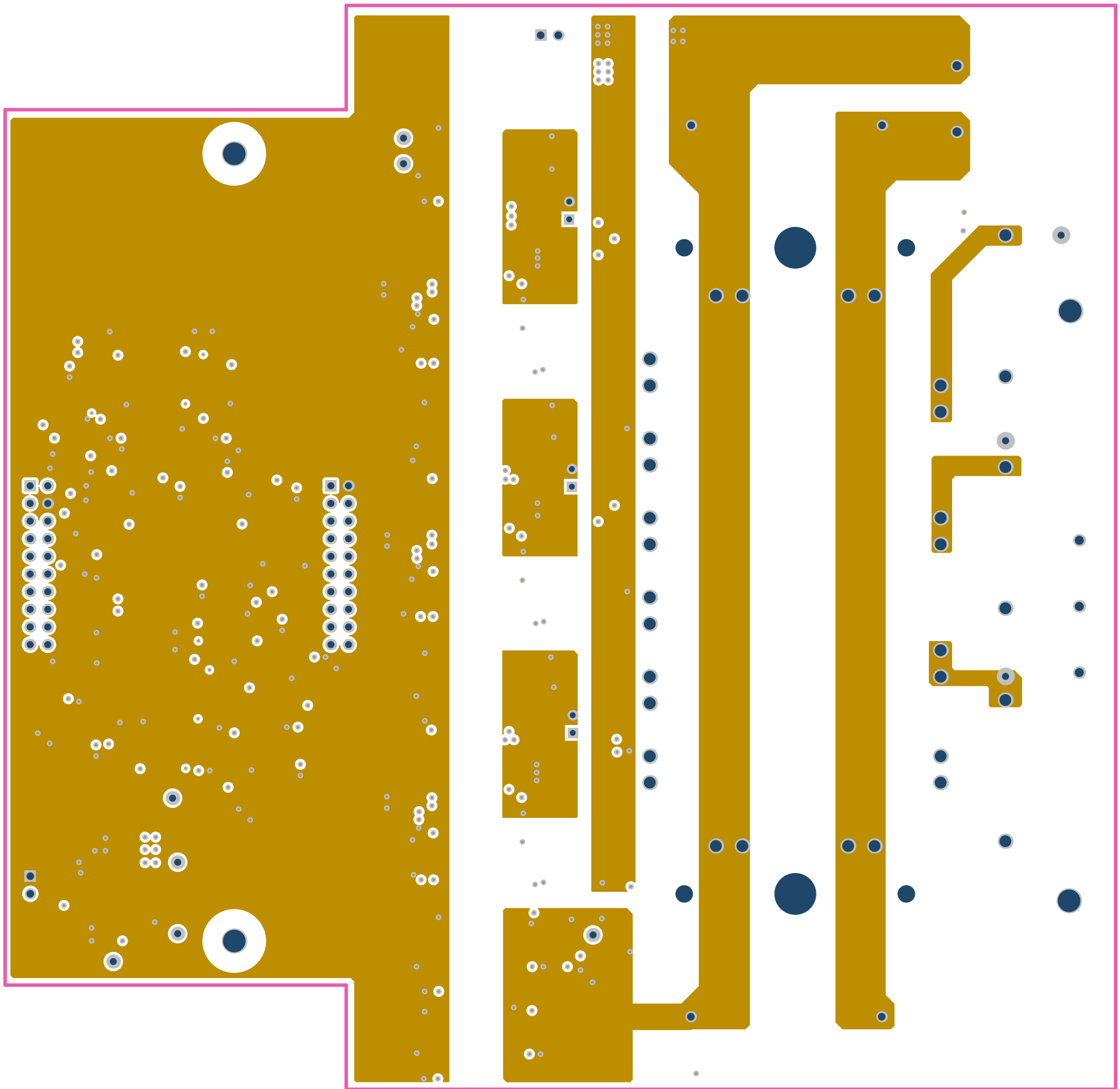
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Paste	TID #: TIDA-01540		
Top Paste	GENERATED : 24-Nov-17	4:25:55 PM	TEXAS INSTRUMENTS



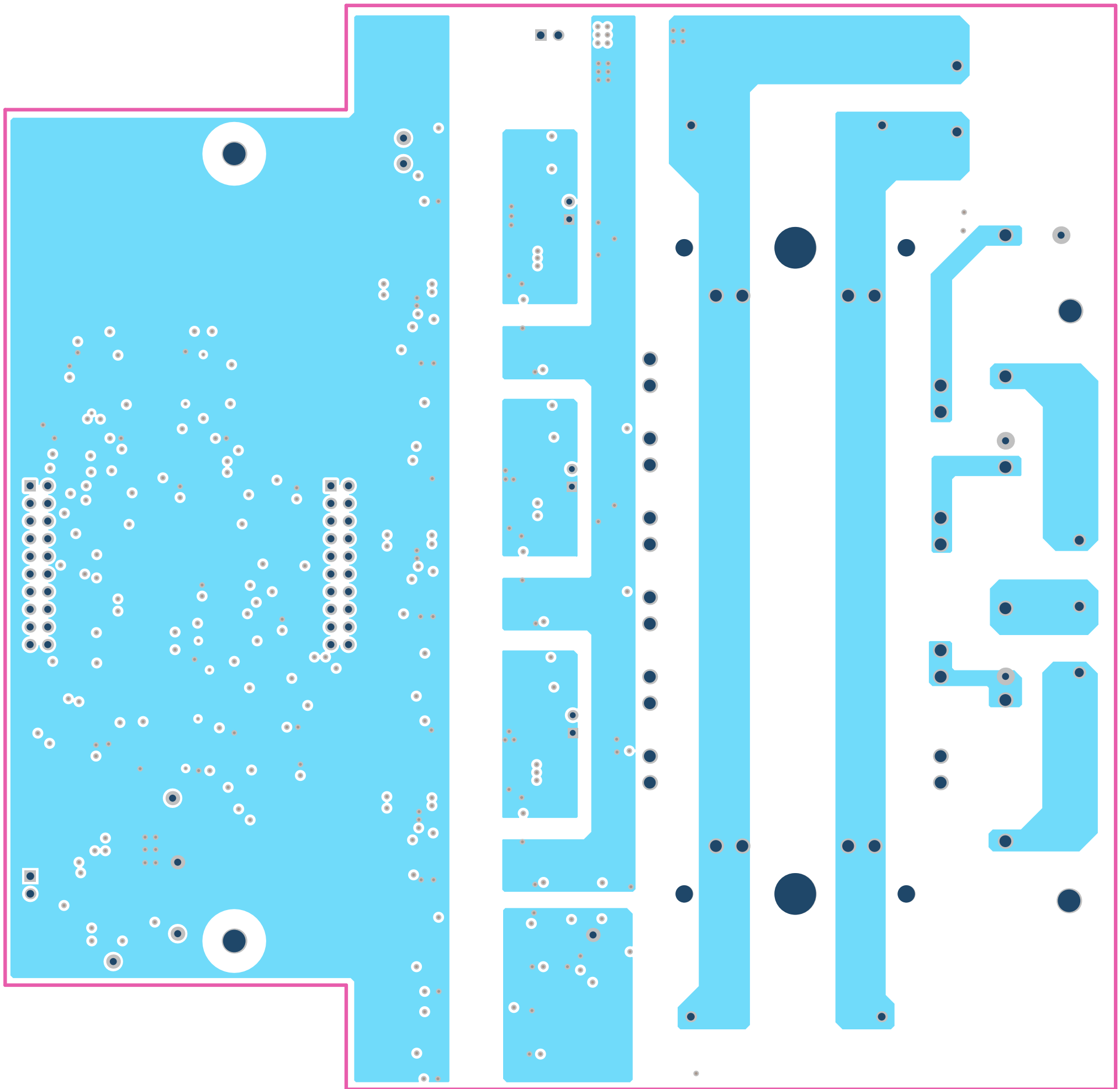
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01540	
Top Solder Mask	GENERATED : 24-Nov-17 4:25:56 PM	TEXAS INSTRUMENTS



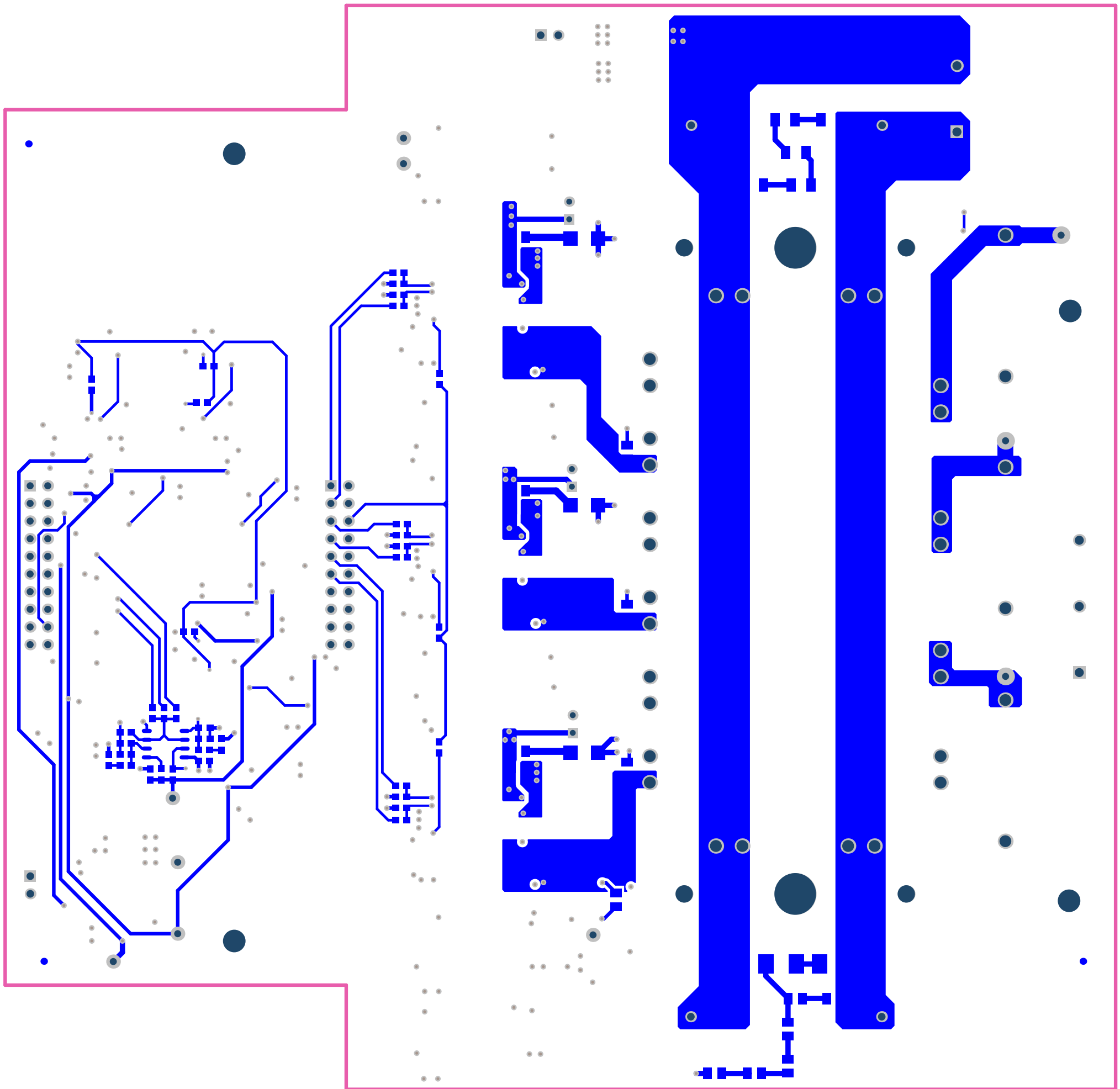
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01540		
Top Layer	GENERATED : 24-Nov-17	4:25:56 PM	TEXAS INSTRUMENTS



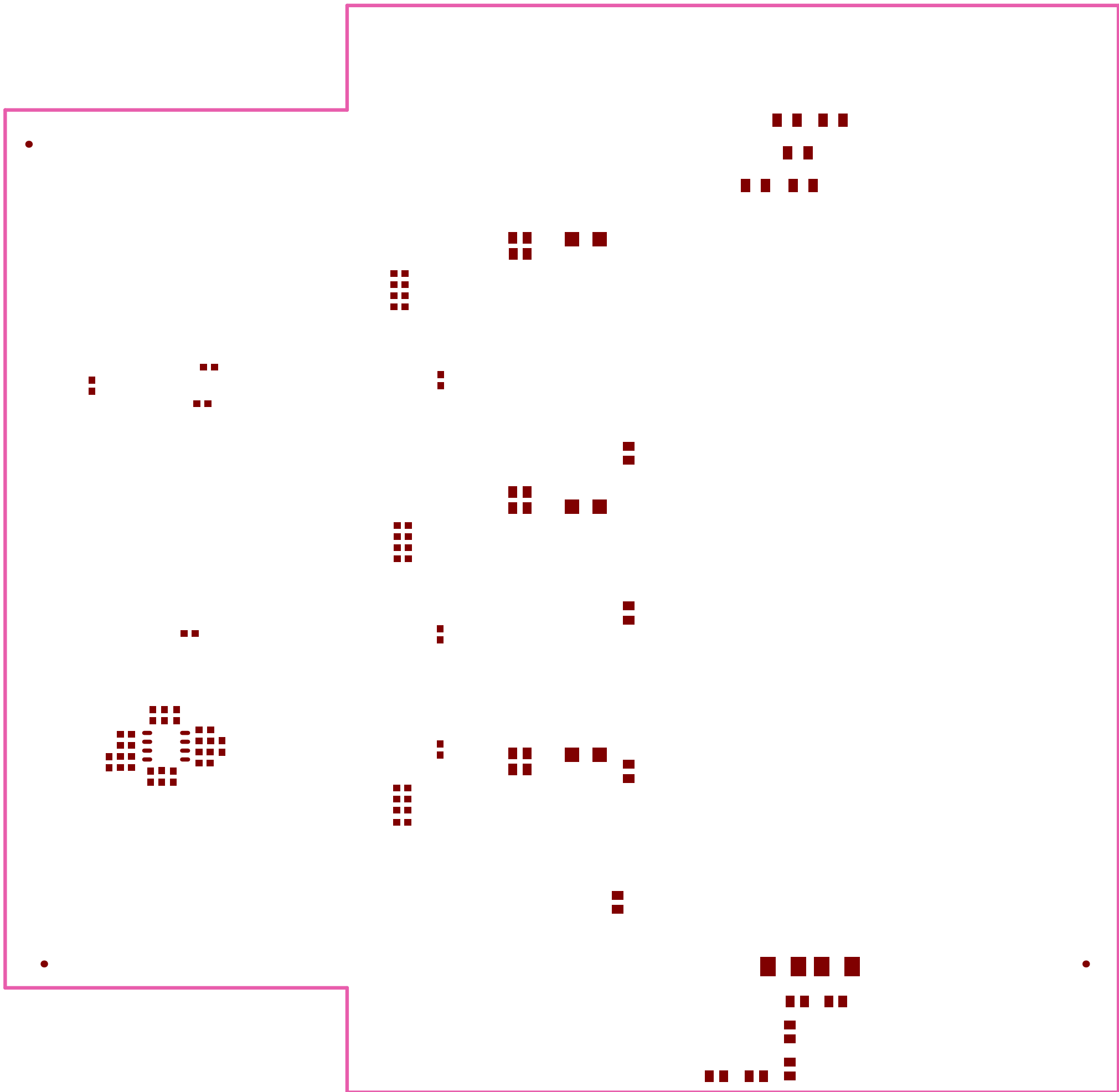
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-01540		
GND	GENERATED : 24-Nov-17	4:25:56 PM	TEXAS INSTRUMENTS



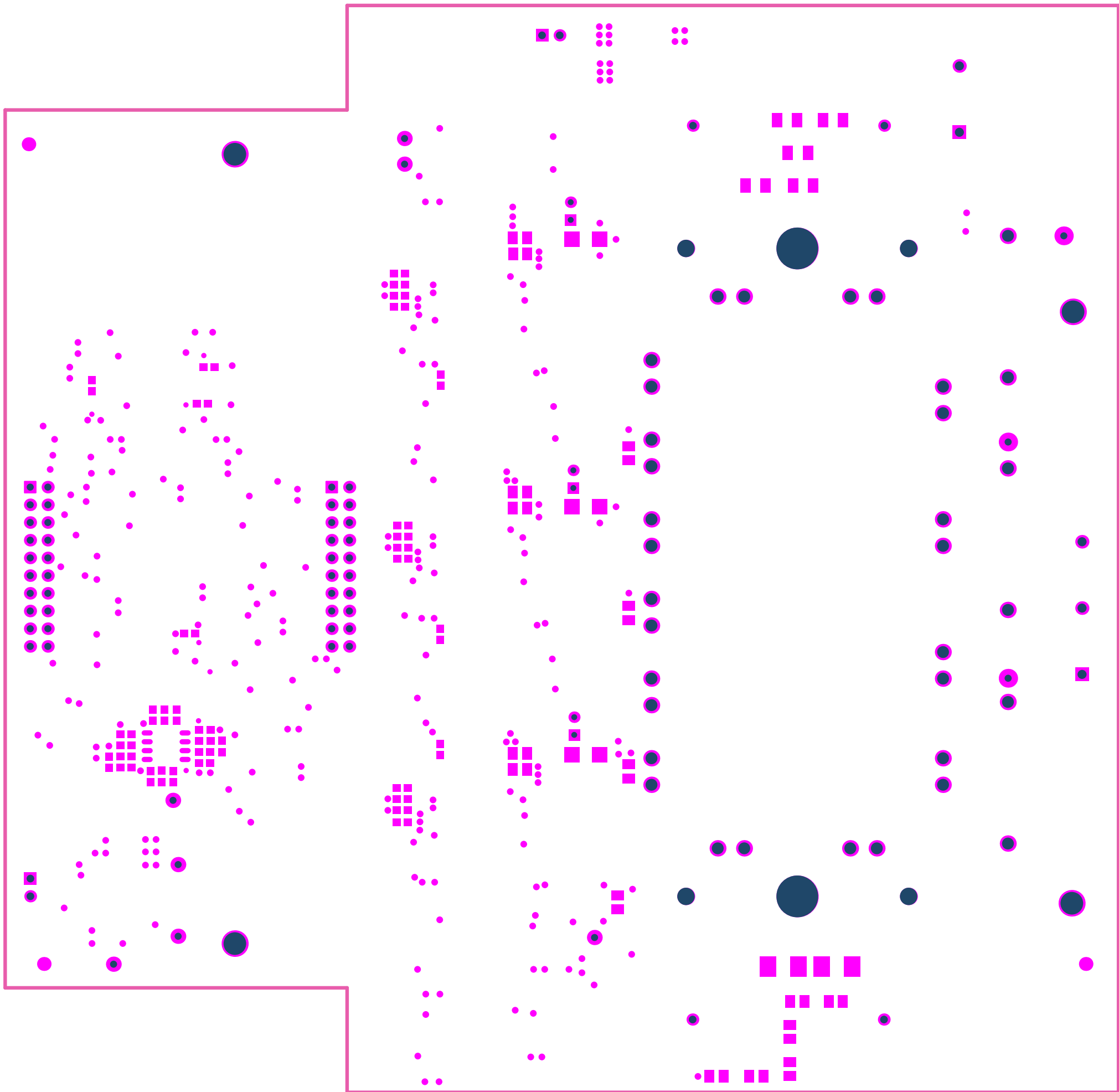
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-01540		
PWR	GENERATED : 24-Nov-17	4:25:56 PM	TEXAS INSTRUMENTS



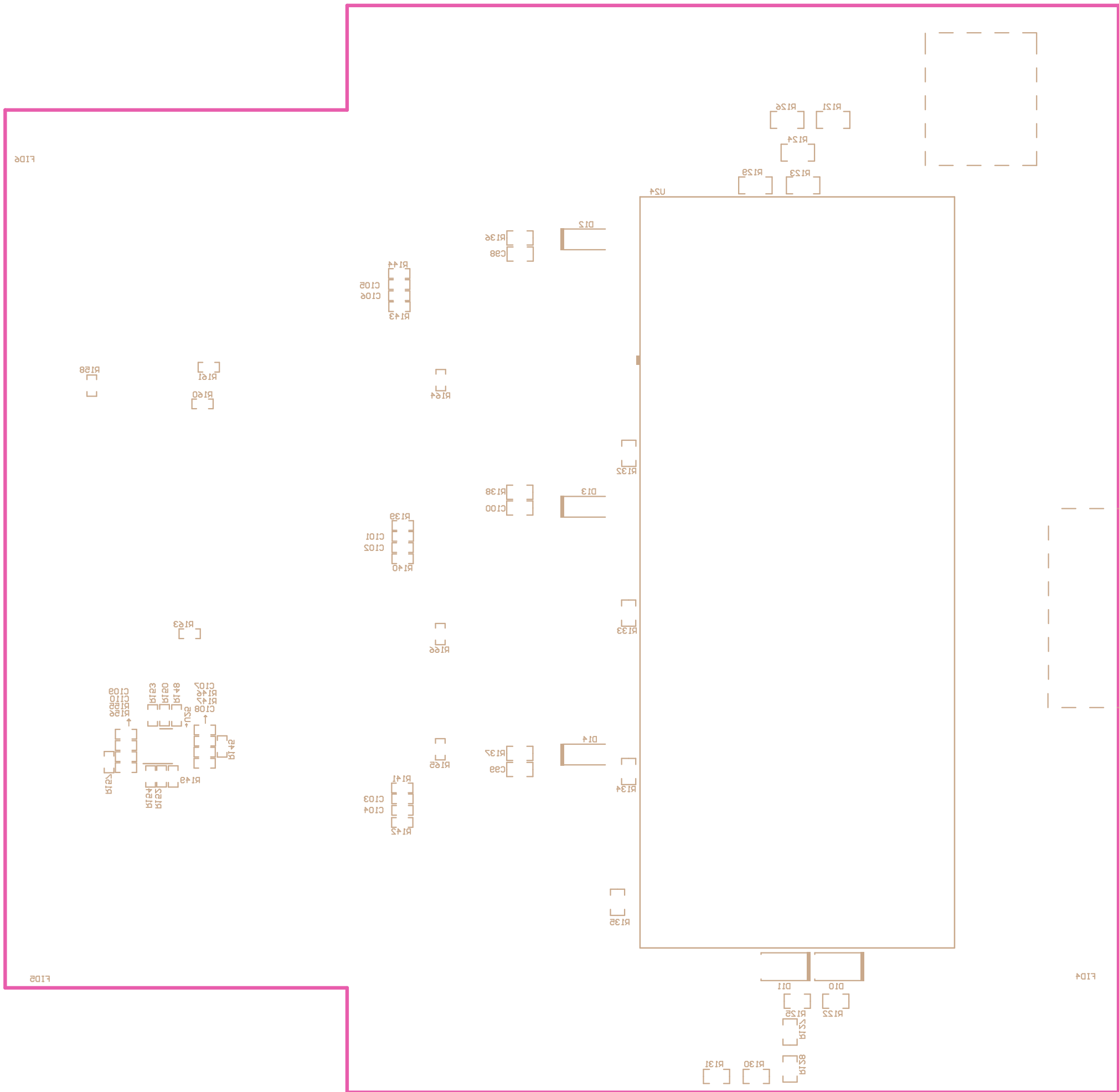
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01540	
Bottom Layer	GENERATED : 24-Nov-17 4:25:56 PM	TEXAS INSTRUMENTS



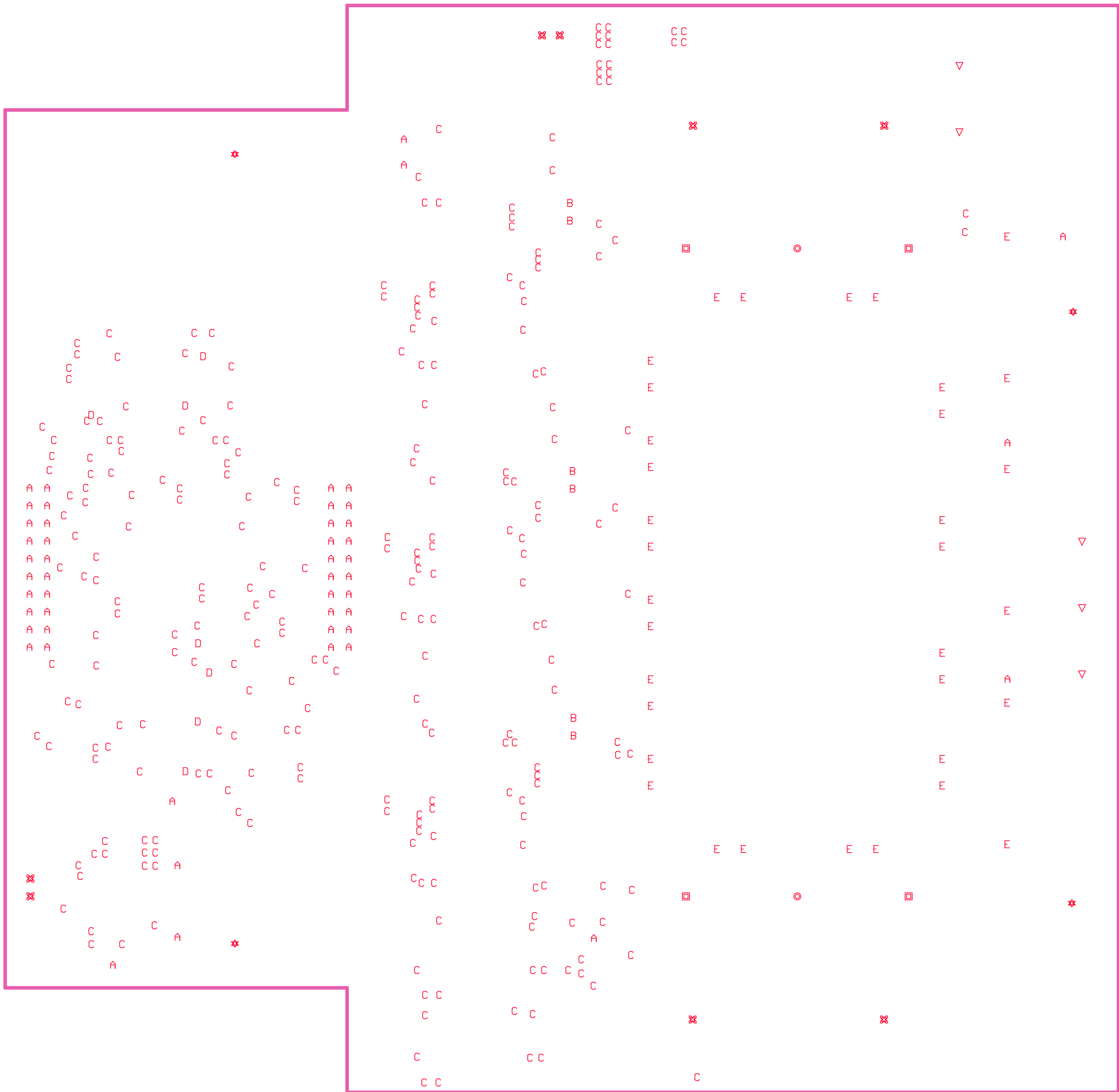
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste	TID #: TIDA-01540	
Bottom paste	GENERATED : 24-Nov-17 4:25:56 PM	TEXAS INSTRUMENTS



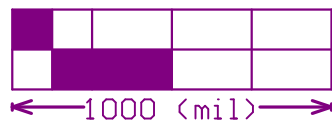
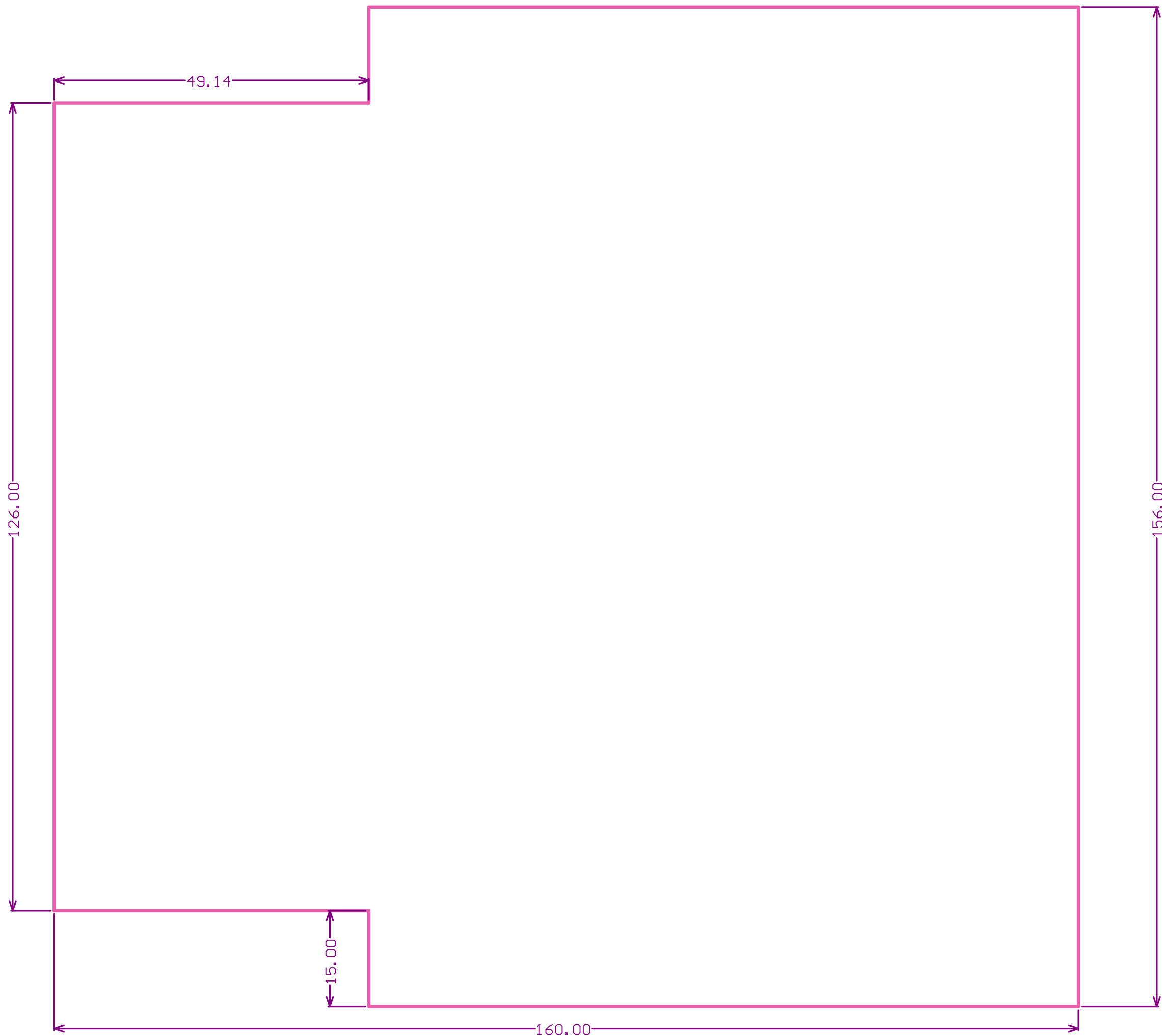
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01540		
Bottom Solder Mask	GENERATED : 24-Nov-17	4:25:56 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01540	
Bottom Overlay	GENERATED : 24-Nov-17 4:25:56 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540	REV: E1	SUN REV: Not In VersionControl	Texas Instruments (TI) and/or any information contained in this document, including the specifications, will be subject to change without notice. TI and/or its agents do not assume any responsibility for the use of the information contained herein. TI and/or its agents do not warrant the accuracy or completeness of the information contained herein. TI and/or its agents do not accept any liability for damages, including consequential damages, arising from the use of the information contained herein. TI and/or its agents do not accept any liability for the use of the information contained herein. TI and/or its agents do not accept any liability for the use of the information contained herein.
LAYER NAME = Drill Drawing	TID #: TIDA-01540			
Drill Drawing	GENERATED : 24-Nov-17	4:25:56 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01540 REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01540	
Board Dimensions	GENERATED : 24-Nov-17 4:25:57 PM	TEXAS INSTRUMENTS

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